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RF3108 TRIPLE-BAND GSM/DCS/PCS POWER AMP MODULE

Package Style: Module (9mmx10mm)

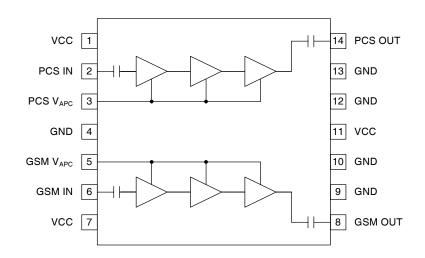


Features

- Single 2.9V to 4.7V Supply Voltage
- +35.5 dBm GSM Output Pwr at 3.5V
- +33.0dBm DCS/PCS Output Pwr at 3.5V
- 55% GSM and 50% DCS/PCS Efficiency
- Supports GSM, E-GSM and DCS/PCS
- 9mmx10mm Package Size

Applications

- 3V Dual-Band/Triple-Band GSM Handsets
- Commercial and Consumer Systems
- Portable Battery-Powered Equipment
- GPRS Class 12 Compatible



Functional Block Diagram

Product Description

The RF3108 is a high-power, high-efficiency power amplifier module offering high performance in GSM or GPRS applications. The device is self-contained with 50Ω input and output terminals. The device is manufactured on an advanced GaAs HBT process, and has been designed for use as the final RF amplifier in GSM/DCS and PCS handheld digital cellular equipment and other applications in the 880MHz to 915MHz and 1710MHz to 1910MHz bands. On-board power control provides over 70dB of control range with an analog voltage input, and provides power down with a logic "low" for standby operation. The device is packaged in an ultra-small (9mmx10mm) LCC, minimizing the required board space.

Ordering Information

RF3108 RF3108PCBA-41X Triple-Band GSM/DCS/PCS Power Amp Module Fully Assembled Evaluation Board

Optimum Technology Matching® Applied

🗹 GaAs HBT	□ SiGe BiCMOS	GaAs pHEMT	🗌 GaN HEMT
GaAs MESFET	🗌 Si BiCMOS	Si CMOS	
🗌 InGaP HBT	SiGe HBT	🗌 Si BJT	

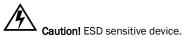
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Absolute Maximum Ratings

-					
Parameter	Rating	Unit			
Supply Voltage	-0.5 to +6.0	V _{DC}			
Power Control Voltage (V _{APC1,2})	-0.5 to +3.0	V			
DC Supply Current	2400	mA			
Input RF Power	+13	dBm			
Duty Cycle at Max Power	50	%			
Output Load VSWR	8:1				
Operating Case Temperature	-40 to +85	°C			
Storage Temperature	-55 to +150	°C			



Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

RoHS status based on EUDirective2002/95/EC (at time of this document revision).

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Devementer	Specification		Unit	Condition	
Parameter	Min.	Тур.	Max.	Unit	Condition
Overall (GSM Mode)					$\label{eq:product} \begin{array}{l} \mbox{Temp=+25°C, V_{CC}=3.5V, V_{APCGSM}=2.6V,} \\ \mbox{P_{IN}=6dBm, Freq=880MHz to 915MHz,} \\ \mbox{25\% Duty Cycle, Pulse Width=1154}\ \mbox{\mu s} \end{array}$
Operating Frequency Range		880 to 915		MHz	
Maximum Output Power	+34.5	35.5		dBm	Temp = 25 °C, V_{CC} = 3.5 V, V_{APCGSM} =2.6 V
	34.0			dBm	50% Duty Cycle, Pulse Width=2308 μ s
	+32.0			dBm	Temp=+85 °C, V _{CC} =2.9V, V _{APCGSM} =2.6V
Total Efficiency	47	55		%	At P _{OUT} , _{MAX} , V _{CC} =3.5V
Input Power for Max Output	+4	+6	+8	dBm	
Output Noise Power			-72	dBm	RBW=100kHz, 925MHz to 935MHz, $P_{OUT} \ge 34.5 dBm$
			-81	dBm	RBW=100 kHz, 935 MHz to 960 MHz, $P_{OUT} \ge 34.5 dBm$
Forward Isolation			-30	dBm	V _{APCGSM} =0.2V, PIN=+8dBm
Second Harmonic		-40	-35	dBc	
Third Harmonic		-50	-43	dBc	
All other non harmonic spurious			-36	dBm	
Input Impedance		50		Ω	
Input VSWR			2.5:1		P _{OUT,MAX} -5dB <p<sub>OUT<p<sub>OUT,MAX</p<sub></p<sub>
Output Load VSWR	8:1				Spurious<-36dBm, V _{APCGSM} =0.2V to 2.6V, RBW=100kHz
Output Load Impedance		50		Ω	Load impedance presented at RF OUT pad
Power Control V _{APC1}					
Power Control "ON"	2.6			V	Max. P _{OUT} , Voltage supplied to the input
Power Control "OFF"	0.2	0.5		V	Min. P _{OUT} , Voltage supplied to the input
Power Control Range		70		dB	V _{APC1.2} =0.2V to 2.6V
Gain Control Slope		100		dB/V	P _{OUT} =-10dBm to 35dBm
APC Input Capacitance			10	pF	DC to 2MHz
APC Input Current		4.5	5	mA	V _{APC} =2.6V
	1		10	μΑ	V _{APC} =0V
Turn On/Off Time			2	μS	V _{APC} =0 to 2.6V



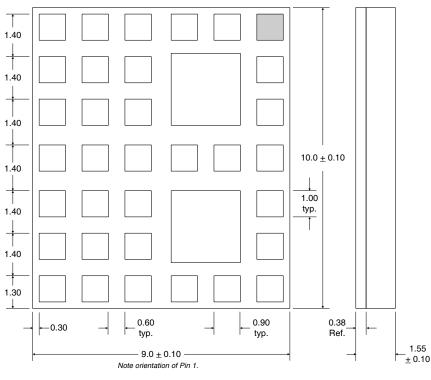


Deveneter	Specification		11	Condition	
Parameter	Min. Typ. Max.	Unit	Condition		
Overall (DCS/PCS Mode)					$\label{eq:constraint} \begin{array}{l} \text{Temp=25^\circ\text{C},V_{\text{CC}}=3.5\text{V},}\\ \text{V}_{\text{APCDCS/PCS}=2.6\text{V},P_{\text{IN}}=6\text{dBm},}\\ \text{Freq=1710\text{MHz}to1910\text{MHz},}\\ \text{25\% Duty Cycle, Pulse Width=1154\mu s} \end{array}$
Operating Frequency Range		1710 to 1910		MHz	
Maximum Output Power	+32	+33		dBm	Temp=25°C, V _{CC} =3.5V, V _{APCDCS/PCS} =2.6V, 1710MHz to 1785MHz
	31.5	32.5		dBm	1850MHz to 1910MHz
	31.5			dBm	50% Duty Cycle, Pulse Width 2308μs, 1710MHz to 1785MHz
	31.0			dBm	1850MHz to 1910MHz
	29.5	30.0		dBm	Temp=+85°C, V _{CC} =2.9V, V _{APC} =2.6V, 1710MHz to 1785MHz
	29.0	29.5		dBm	1850MHz to 1910MHz
Total Efficiency	45	52		%	At P _{OUT,MAX} , V _{CC} =3.5V, 1710MHz to 1785MHz
	40	47		%	At P _{OUT,MAX} , V _{CC} =3.5V, 1850MHz to 1910MHz
Recommended Input Power Range	+4	+6	+8	dBm	
Output Noise Power			-77	dBm	RBW=100 kHz, 1805 MHz to 1880 MHz and 1930 MHz to 1990 MHz, $P_{OUT} \ge 34.5 dBm, V_{CC} = 3.5 V$
Forward Isolation		-37	-30	dBm	V _{APCDCS/PCS} =0.2V, P _{IN} =+8dBm
Second Harmonic		-60	-45	dBc	P _{OUT} , = +32.5 dBm
Third Harmonic		-65	-50	dBc	
All other spurious			-36	dBm	
Input Impedance		50		Ω	
Input VSWR		-	2.5		P _{OUT,MAX} -5dB <p<sub>OUT<p<sub>OUT,MAX</p<sub></p<sub>
Output Load VSWR	8:1				Spurious<-36dBm, V _{APCDCS/PCS} =0.2V to 2.6V, RBW=100kHz
Output Load Impedance		50		Ω	Load impedance presented at RF OUT pin
Power Control V _{APC2}					
Power Control "ON"			2.6	V	Max. P _{OUT} , Voltage supplied to the input
Power Control "OFF"	0.2	0.5		V	Min. P _{OUT} , Voltage supplied to the input
Power Control Range	62	68		dB	V _{APC1,2} =0.2V to 2.6V, P _{IN} =+8dBm
Gain Control Slope		100		dB/V	P _{OUT} =-10dBm to +33dBm
APC Input Capacitance			10	pF	DC to 2MHz
APC Input Current		4.5	5	mA	V _{APC} =2.6V
			10	μΑ	V _{APC} =0V
Turn On/Off TIme			100	ns	V _{APC} =0to2.6V
Overall Power Supply					
Power Supply Voltage		3.5		V	Specifications
-	2.9		4.7	V	Nominal operating limits, P _{OUT} <+33dBm
	2.9		4.3	V	50% Duty Cycle, Pulse Width 2308 µs
Power Supply Current		2		А	DC Current at P _{OUT,MAX}
		1	10	μА	P _{IN} <-30dBm, V _{APC1,2} =0.2V, Temp=-40to+85 °C

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Pin	Function	Description	Interface Schematic
1	VCC1	Power Supply for the driver stage of the DCS/PCS band.	
2	DCS/PCS IN	RF Input to the DCS/PCS band. This is a 50 Ω input.	
3	DCS/PCS	Power control for the pre-amplifier, driver, and output stage of the	
	V _{APC}	DCS/PCS band.	
4	GND	Ground connection to overall package.	
5	GSM V _{APC}	Power control for the pre-amplifier, driver, and output stage of the GSM band.	
6	GSM IN	RF input to the GSM band. This is a 50 Ω input.	
7	VCC2	Power supply for the driver stage of the GSM band.	
8	GSM OUT	RF output for the GSM band. This is a 50 Ω output. The output load line matching is contained internal to the package.	
9	GND	Ground connection to overall package.	
10	GND	Ground connection to overall package.	
11	VCC3	Power supply for the pre-amplifier and output stage for both the DCS/PCS and GSM bands.	
12	GND	Ground connection to overall package.	
13	GND	Ground connection to overall package.	
14	DCS/PCS	RF output for the DCS/PCS band. This is a 50Ω output. The output load	
	OUT	line matching is contained internal to the package.	
Pkg Base	GND	Ground connection to overall package.	

Package Drawing



NOTE: Shaded area represents Pin 1.





Theory of Operation and Application Information

The RF3108 is a triple-band, GSM/DCS/PCS power amplifier with two separate RF inputs and outputs that are internally matched to 50Ω. Pins 2 and 14 of the device provide the RF input and output for the DCS/PCS band, which is optimized for performance between 1710MHz and 1910MHz. Pins 5 and 8 of the device provide the RF input and output for the GSM band, which is optimized for performance between 880MHz and 915MHz. Both bands include an internal DC-blocking capacitor to protect the device from external DC source inputs and block internal DC from exiting the inputs and outputs of the module. The performance is similar to the performance of the RF2173 and RF2174 MIMIC devices used in dual- or triple-band applications. However, the RF3108 module includes the matching and bypass capacitors required for operation internal to the 9mmx10mm module. However, some external components are required to improve stability, isolation and noise power performance. These components are included on the evaluation board and schematic, and will be described in the following paragraphs.

The GSM 900MHz band provides 32dB and the DCS/PCS 1710MHz to 1910MHz band provides 28dB of small signal gain at full output power. Therefore, the drive level required to fully saturate the output is +4dBm for each band. Based upon HBT (Heterojunction Bipolar Transistor) technology, the part requires only a single positive 3V supply to operate to full specification. The DCS/PCS band input is located at pin 2 of the device and requires no external components. The GSM 900MHz band input is located at pin 6 of the device and also does not require external components. However, a 180 Ω resistor is included at the input of the GSM band to improve the input impedance and isolation performance at low V_{APC} levels. The output for both high and low bands are internally matched to 50 Ω at the output of pin 14 and 8. A 50 Ω microstrip should be used to interface to the input and output connections.

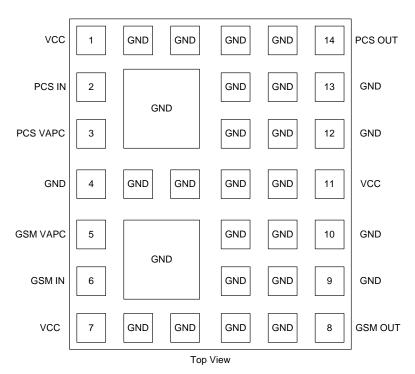
Power control for the GSM 900MHz band is provided through pin 5 of the device, and pin 3 for the DCS/PCS band. The V_{APC} inputs do not contain any internal bypass capacitors and will require some external filtering. Because the V_{APC} filtering capacitor is external to the device, the user has the option of choosing a capacitor value that meets the control loop BW and filtering requirement for various applications. In most typical applications with a closed loop power control, the recommended bypass capacitor for this input is approximately 33 pF for the GSM band, and 12 pF for the DCS/PCS band. However in open loop operation, a 10 nF V_{APC} bypass capacitor is recommended for both bands to filter noise from the external V_{APC} source. A 10 nF capacitor is installed on pins 3 and 5 on the current evaluation board (see the evaluation board schematic). Noise on the V_{APC} input will degrade the noise power performance of the device, so care should be used to provide a clean V_{APC} input signal. This is especially important when measuring noise power or stability performance.

The voltage supply V_{CC} contains internal bypass capacitors and inductors to filter unwanted noise on the DC supply voltage. However, the main V_{CC} input to the device at pin 11 requires some additional bypass capacitors as shown in the evaluation board schematic. C5 (1uF) and C4 (3.3uF) are required to improve the stability performance.

All the internal ground connections are connected to a series of ground pads located on the backside of the package as shown in the pin out diagram. Pins 4, 9, 10, 12, and 13 are also ground connections. The final stages of both bands are connected to the ground pads on the backside of the package. Therefore this ground connection is essential to dissipate heat and to provide proper current flow. Refer to the evaluation board layout as an example of the vias locations and quantity required for proper connection.

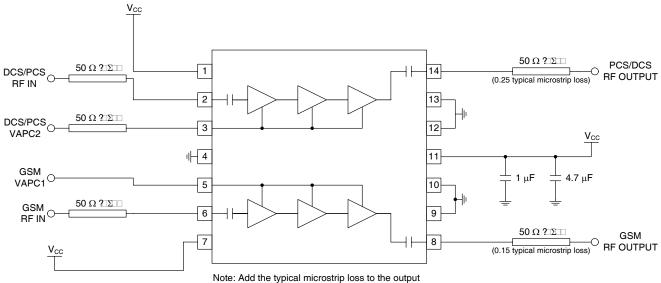


Pin Out



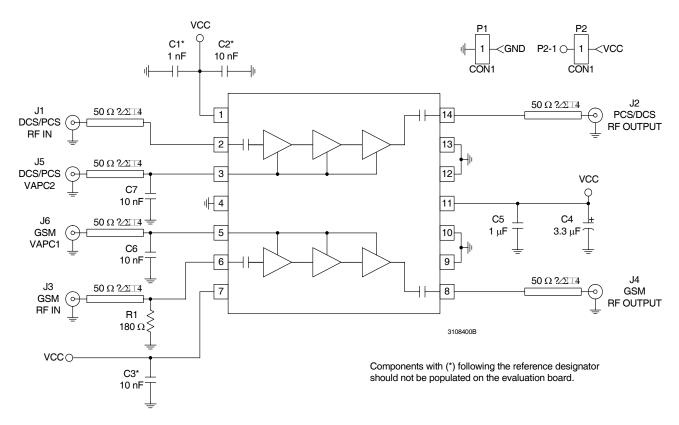


Application Schematic



Note: Add the typical microstrip loss to the output power measured at the output connector of evaluation board to calculate the actual power at the RF3108 module output pin.

Evaluation Board Schematic







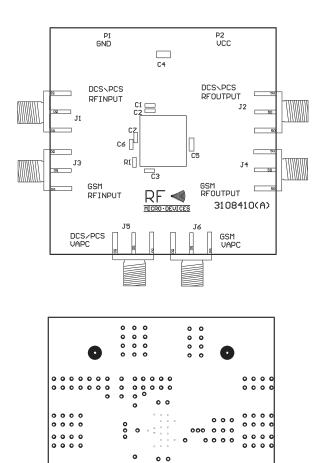
Evaluation Board Layout

Board Size 2.0" x 2.0"

Board Thickness 0.031"; Board Material FR-4; Multi-Layer







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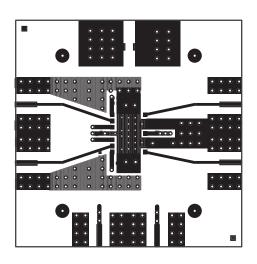
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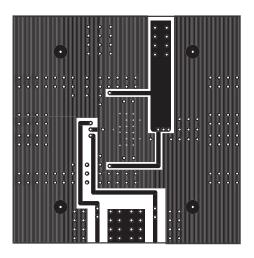
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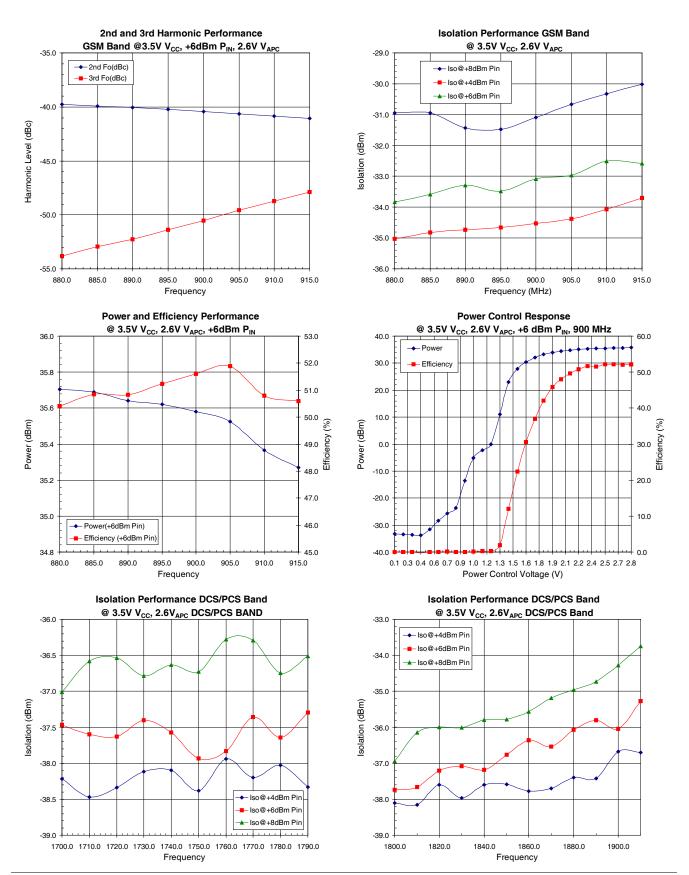
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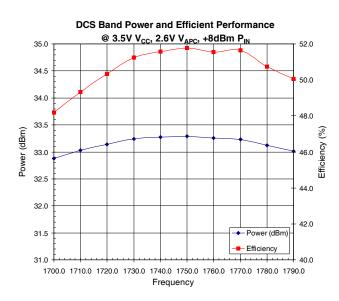


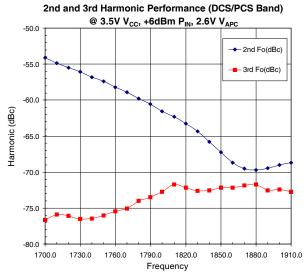
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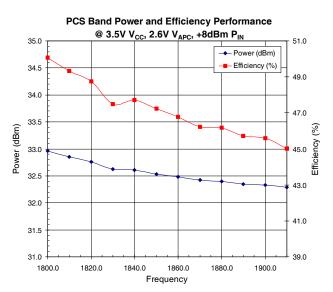




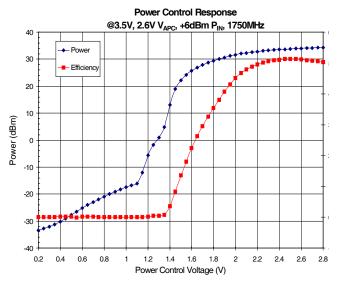
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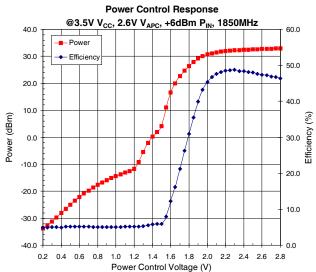






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